

BRS 882 (load or hold or loader or holder) with (semiconductor or wafer or substrate) with finger US-PGPUB; USPAT; EPO; JPO
BRS 24725 (lift or guide) with finger US-PGPUB; USPAT; EPO; JPO
BRS 130 S1 and S2 US-PGPUB; USPAT; EPO; JPO
IS&R 69048 ("451").CLAS. US-PGPUB; USPAT; EPO; JPO
BRS 2 S3 and S4 US-PGPUB; USPAT; EPO; JPO
BRS 14 ("5335453" | "5738574" | "5804507" | "5908347" | "5908530" | "6110024" | "6227946" | "6227950" | "6241585" | "6296550" | "6302767").PN. OR ("6435941").URPN. US-PGPUB; USPAT; USOCR
IS&R 2 ((("6227950") or ("6435941"))).PN. USPAT
BRS 925269 fluid or spray or nozzle USPAT
BRS 2 S7 and S8 USPAT
BRS 89043 height with (adjust\$ or change) USPAT
BRS 0 S9 and S10 USPAT
BRS 5157 (robot\$ with arm) with (finger or hold\$) US-PGPUB; USPAT; EPO; JPO
BRS 1435793 load US-PGPUB; USPAT; EPO; JPO
BRS 1750 S12 and S13 US-PGPUB; USPAT; EPO; JPO
BRS 177 (robot\$ with arm) with (finger or hold\$) with (center\$) US-PGPUB; USPAT; EPO; JPO
BRS 258 (robot\$ with arm) with (finger or hold\$) with (lift\$) US-PGPUB; USPAT; EPO; JPO
BRS 16 (robot\$ with arm) with (finger or hold\$) with (lift\$) with (center\$) US-PGPUB; USPAT; EPO; JPO
BRS 2324601 wafer or semiconductor or substrate US-PGPUB; USPAT; EPO; JPO
BRS 15 S17 and S18 US-PGPUB; USPAT; EPO; JPO
IS&R 1377 (451/285).CCLS. US-PGPUB; USPAT; EPO; JPO
IS&R 440 (451/10).CCLS. US-PGPUB; USPAT; EPO; JPO
IS&R 1346 (451/11).CCLS. US-PGPUB; USPAT; EPO; JPO
IS&R 1407 (451/287).CCLS. US-PGPUB; USPAT; EPO; JPO
IS&R 308 (451/331).CCLS. US-PGPUB; USPAT; EPO; JPO
IS&R 422 (414/783).CCLS. US-PGPUB; USPAT; EPO; JPO
IS&R 62 (414/784).CCLS. US-PGPUB; USPAT; EPO; JPO
IS&R 483 (414/936).CCLS. US-PGPUB; USPAT; EPO; JPO
IS&R 559 (414/941).CCLS. US-PGPUB; USPAT; EPO; JPO
BRS 285195 finger US-PGPUB; USPAT; EPO; JPO
BRS 958 S27 or S28 US-PGPUB; USPAT; EPO; JPO
BRS 97 S29 and S30 US-PGPUB; USPAT; EPO; JPO
BRS 84 S27 and S28 US-PGPUB; USPAT; EPO; JPO
BRS 13 S29 and S32 US-PGPUB; USPAT; EPO; JPO
BRS 455538 finger or claw US-PGPUB; USPAT; EPO; JPO
BRS 15 S32 and S34 US-PGPUB; USPAT; EPO; JPO